APPLICA	BLE STAN	IDARD									
Operating		\wedge	A 55.00 1 105.00(1)		Storage				-10 °C to 60 °C (2)		
	Temperature Range 2		Signal Contact : 50 V AC			mperature Range			Relative humidity 85% max (Not dewed)		
Rating			Power Contact : 200 V AC Signal Contact : 0.5 A			orage Humidity Range					
	Current		Power Contact : 3.0A			perating Humidity Range					
	•	,	SPEC	IFICA	TION	S					
IT	EM		TEST METHOD				REC	QUIF	REMENTS	QT	АТ
CONSTRU								-,		1	1
General Examination		Visually and by measuring instrument.				According to drawing.					×
Marking		Confirmed visually.									×
ELECTRIC CHARACT											
Contact Resistance		100 mA(DC or 1000Hz)				Signal Contact : $70m\Omega$ MAX. Power Contact : $20m\Omega$ MAX.				×	-
Insulation Resistance Voltage Proof MECHANICAL CHAR.		Signal Contact : 100 V DC.				Signal Contact : 100 MΩMIN.				×	_
		Power Contact : 250 V DC				Power Contact : 1000 M Ω MIN.					
		Signal Contact : 150 V AC for 1 min.				No flashover or breakdown.					×
		Power Contact : 600 V AC for 1 min.				The hashever of breakdown.					_
						Lean 2		-	OO NI MANY		
Insertion and Withdrawal Forces		Measured by applicable connector.				Insertion Force: 36 N MAX. Withdrawal Force: 4 N MIN.				×	-
Mechanical Operation		100 times insertions and extractions.				Contact Resistance:				×	+-
						Signal Contact : 80m Ω MAX. Power Contact : 30m Ω MAX. ② No damage, crack and looseness of parts.					
Vibration		Frequenc	Frequency 10 to 55 to 10Hz, approx 5min				① No electrical discontinuity of 1 μs.				_
		Single amplitude : 0.75 mm, 10 cycles for 3 axial directions.				② No damage, crack and looseness of parts.					
Shock		490 m/s ² , duration of pulse 11 ms at 3 times for 3 both axial directions.								×	-
FNVIRON	MENTAL C		TERISTICS								
Damp Heat	WEITH C		at 40±2 °C, 90 ~ 95 %;	. 96 h.		① Cor	ntact Resis	stance	<u> </u>	×	Ι_
(Steady state)					•	_	ignal Con		80m Ω MAX.		
Rapid Change of		Temperature -55 → +85 °C			Power Contact : 30m Ω MAX.				×	_	
Temperature		Time $30 \rightarrow 30$ min.				_	ulation Re				
		under 5 cycles. (Relocation time to chamber : within 2~3 MIN)				Signal Contact : 100 MΩ MIN. Power Contact : 1000 MΩ MIN.					
Cold		Exposed at -55°C, 96 h				③ No damage, crack and looseness of parts.① Contact Resistance:				×	
Dry Hoot A		E 1 1 105°0 00 1				Signal Contact : $80m\Omega$ MAX. Power Contact : $30m\Omega$ MAX.					
Dry Heat	<u>/2\</u>	Exposed at 105°C, 96 h				No damage, crack and looseness of parts.				×	_
Sulfur Dioxide		Exposed at 25±2°C, 75±5%RH, 25 PPM for 96 h.				No defect such as corrosion which impairs				×	_
			(Test standard: IEC 68)				the function of connector.				
						② Contact Resistance:					
							ignal Con		80m Ω MAX. 30m Ω MAX.		
Resistance to		1)Reflows	1)Reflow soldering :				Power Contact : 30m Ω MAX. No deformation of case of excessive				<u> </u>
Soldering Heat		Peak TMP : 260°CMAX				looseness of the terminal.					
			TMP: 220°CMIN for 60sec								
Coldorobility			ng irons : 360°C MAX. for 5	sec.		Λ now.	uniform of	a eti n a	of colder shall sover a	1	
Solderability	Solderability		Soldered at solder temperature 240±3°C for immersion duration, 3 sec.			A new uniform coating of solder shall cover a minimum of 95 % of the surface being				×	_
COUNT [ESCRIPTION OF REVISIONS DESIGNATION DE LA CONTRACTION				immersed. GNED CHECKED					TE
Δ	11 D										TE
		DIS-F-00002058 TS. ature rise caused by current-carrying.			TS. 00				HT. YAMAGUCHI		2. 01
TEINIMININO	"STORAGE" m	acure rise caus neans a long-te	a long-term storage state for the unused product			APPROVED CHECKED			HS. OKAWA	14.09.0	
before assembly to PCB.						-			KN. SHIBUYA	14. 09. 02	
Unless otherwise specified rafe			er to IEC 60512			DESIGNED			TS. 00NO	14. 09. 02 14. 09. 02	
Unless otherwise specified, refer to IEC 6 Note QT:Qualification Test AT:Assurance T						DRAWN		IN	TS. 00N0 14. 09. ELC-353568-00-00		
					PART	RAWING NO.		 F	FX23-80S-0, 5SH		,
HS.	SPECIFICATION SHEET HIROSE ELECTRIC CO., LTD.					0.570					1/1
FORM HD0011:		NOSE EL	LOTRIO CO., LTD.		CODE	NU.	UL:	J/J	-3404-7-00	<u>/2\</u>	1/ I